

NOTE: This disposition is nonprecedential.

**United States Court of Appeals
for the Federal Circuit**

DANIEL L. FLAMM,
Appellant

v.

**MICRON TECHNOLOGY, INC., INTEL
CORPORATION, GLOBALFOUNDRIES U.S., INC.,
SAMSUNG ELECTRONICS COMPANY, LTD.,**
Appellees

2018-2384, 2018-2385

Appeals from the United States Patent and Trademark
Office, Patent Trial and Appeal Board in Nos. IPR2017-
00392, IPR2017-00406, IPR2017-01747, IPR2017-01748.

JUDGMENT

ROLF STADHEIM, Stadheim & Grear, Scottsdale, AZ, argued for appellant.

JARED BOBROW, Orrick, Herrington & Sutcliffe LLP, Menlo Park, CA, argued for appellees Micron Technology, Inc., Intel Corporation and GLOBALFOUNDRIES U.S., Inc. Appellee Micron Technology, Inc. also represented by JEREMY JASON LANG; MELANIE L. BOSTWICK, Washington,

DC.

CHAD S. CAMPBELL, Perkins Coie LLP, Phoenix, AZ, for appellee Intel Corporation. Also represented by TYLER R. BOWEN; DAN L. BAGATELL, Hanover, NH; PHILIP ALCIDE MORIN, San Diego, CA; JONATHAN L. MCFARLAND, Seattle, WA.

SHAMITA ETIENNE-CUMMINGS, White & Case LLP, Washington, DC, for appellee GLOBALFOUNDRIES U.S., Inc. Also represented by DAVID TENNANT.

NAVEEN MODI, Paul Hastings LLP, Washington, DC, for appellee Samsung Electronics Company, Ltd.

THIS CAUSE having been heard and considered, it is

ORDERED and ADJUDGED:

PER CURIAM (PROST, *Chief Judge*, PLAGER and STOLL, *Circuit Judges*).

AFFIRMED. See Fed. Cir. R. 36.

ENTERED BY ORDER OF THE COURT

September 6, 2019

Date

/s/ Peter R. Marksteiner

Peter R. Marksteiner
Clerk of Court